

## Low-Cost, CMOS, Rail-to-Rail, I/O OPERATIONAL AMPLIFIERS

### FEATURES

- RAIL-TO-RAIL INPUT AND OUTPUT
- WIDE SUPPLY RANGE:  
Single Supply: 4V to 12V  
Dual Supplies:  $\pm 2$  to  $\pm 6$
- LOW QUIESCENT CURRENT: 160 $\mu$ A
- LIMITED RANGE CMRR: 96dB
- LOW OFFSET: 0.5mV
- HIGH SPEED: 1MHz, 0.6V/ $\mu$ s
- *Micro*SIZE PACKAGES:  
SOT23-5, MSOP-8, TSSOP-14
- LOW INPUT BIAS CURRENT: 1pA

### APPLICATIONS

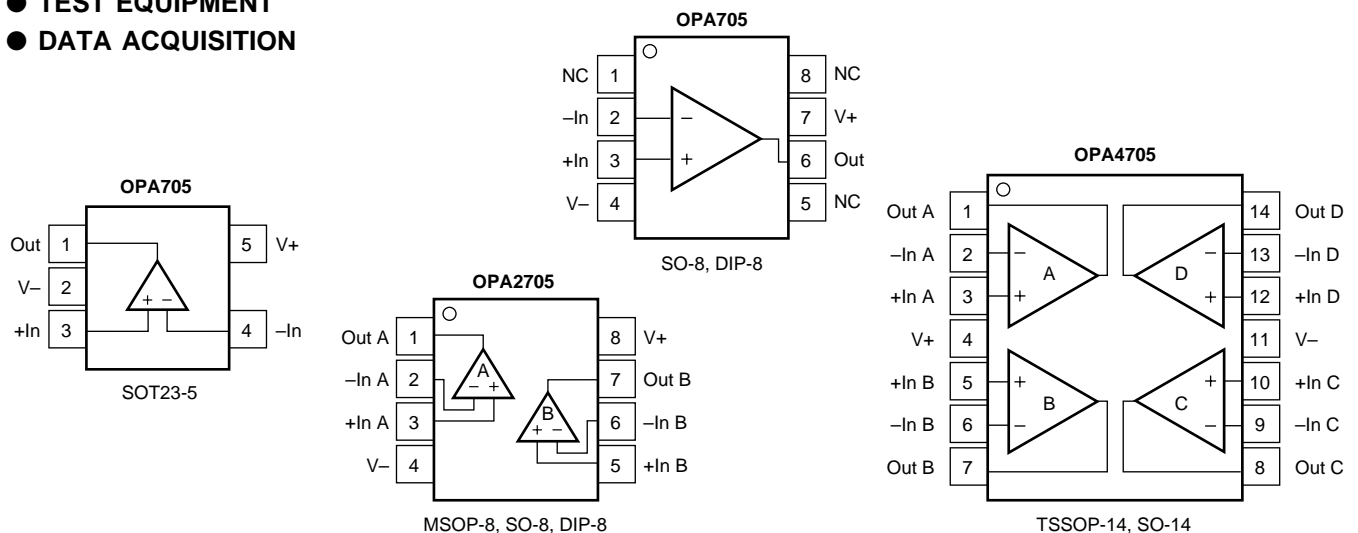
- AUTOMOTIVE APPLICATIONS:  
Audio, Sensor Applications, Security Systems
- PORTABLE EQUIPMENT
- ACTIVE FILTERS
- TRANSDUCER AMPLIFIER
- TEST EQUIPMENT
- DATA ACQUISITION

### DESCRIPTION

The OPA705 series low-cost op amps are optimized for applications requiring rail-to-rail input and output swing. Single, dual, and quad versions are offered in a variety of packages. While the quiescent current is less than 200 $\mu$ A per amplifier, the OPA705 still offers excellent dynamic performance (1MHz GBW and 0.6V/ $\mu$ s SR) and unity-gain stability.

The OPA705 series is fully specified and guaranteed over the supply range of  $\pm 2$ V to  $\pm 6$ V. Input swing extends 300mV beyond the rail and the output swings to within 40mV of the rail.

The single version (OPA705) is available in the *Micro*SIZE SOT23-5 and in the standard SO-8 surface-mount packages. The dual version (OPA2705) is available in the MSOP-8, SO-8, and DIP-8 packages. The quad OPA4705 is available in the TSSOP-14 and SO-14 packages. All are specified for operation from  $-40^{\circ}$ C to  $+85^{\circ}$ C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

Supply Voltage, V+ to V-.....	13.2V
Signal Input Terminals, Voltage <sup>(2)</sup> ..... (V-) -0.3V to (V+) +0.3V	
Current <sup>(2)</sup> .....	10mA
Output Short-Circuit <sup>(3)</sup> .....	Continuous
Operating Temperature.....	-55°C to +125°C
Storage Temperature.....	-65°C to +150°C
Junction Temperature.....	+150°C
Lead Temperature (soldering, 10s).....	+300°C

NOTES: (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. (2) Input terminals are diode-clamped to the power supply rails. Input signals that can swing more than 0.3V beyond the supply rails should be current-limited to 10mA or less. (3) Short-circuit to ground, one amplifier per package.



## ELECTROSTATIC DISCHARGE SENSITIVITY

This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## PACKAGE/ORDERING INFORMATION

PRODUCT	DESCRIPTION	MINIMUM RECOMMENDED GAIN	PACKAGE	PACKAGE DRAWING NUMBER	PACKAGE MARKING	ORDERING NUMBER <sup>(1)</sup>	TRANSPORT MEDIA
OPA705NA "	Single, GBW = 1MHz "	1 "	SOT23-5 "	331 "	A05 "	OPA705NA/250 OPA705NA/3K	Tape and Reel Tape and Reel
OPA705UA "	Single, GBW = 1MHz "	1 "	SO-8 "	182 "	OPA705UA "	OPA705UA OPA705UA/2K5	Rails Tape and Reel
OPA705PA	Single, GBW = 1MHz	1	DIP-8	006	OPA705PA	OPA705PA	Rails
OPA2705EA "	Dual, GBW = 1MHz "	1 "	MSOP-8 "	337 "	B05 "	OPA2705EA/250 OPA2705EA/2K5	Tape and Reel Tape and Reel
OPA2705UA "	Dual, GBW = 1MHz "	1 "	SO-8 "	182 "	OPA2705UA "	OPA2705UA OPA2705UA/2K5	Rails Tape and Reel
OPA2705PA	Dual, GBW = 1MHz	1	DIP-8	006	OPA2705PA	OPA2705PA	Rails
OPA4705EA "	Quad, GBW = 1MHz "	1 "	TSSOP-14 "	357 "	OPA4705EA "	OPA4705EA/250 OPA4705EA/2K5	Tape and Reel Tape and Reel
OPA4705UA "	Quad, GBW = 1MHz "	1 "	SO-14 "	235 "	OPA4705UA "	OPA4705UA OPA4705UA/2K5	Rails Tape and Reel

NOTE: (1) Models with a slash (/) are available only in Tape and Reel in the quantities indicated (e.g., /3K indicates 3000 devices per reel). Ordering 3000 pieces of "OPA705NA/3K" will get a single 3000-piece Tape and Reel.

# ELECTRICAL CHARACTERISTICS: $V_S = 4V$ to $12V$

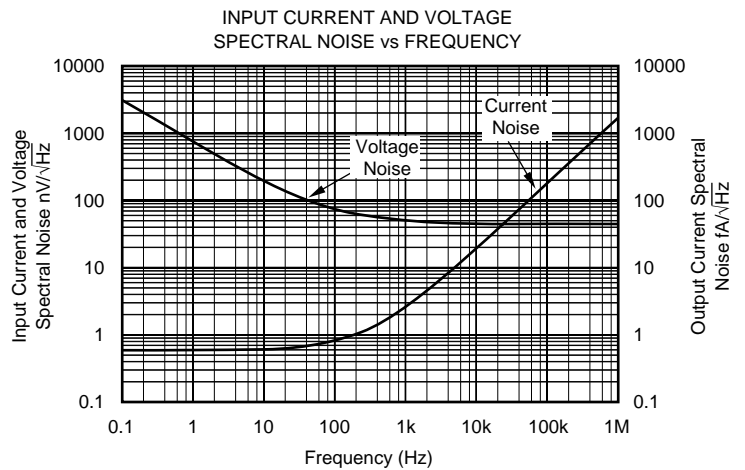
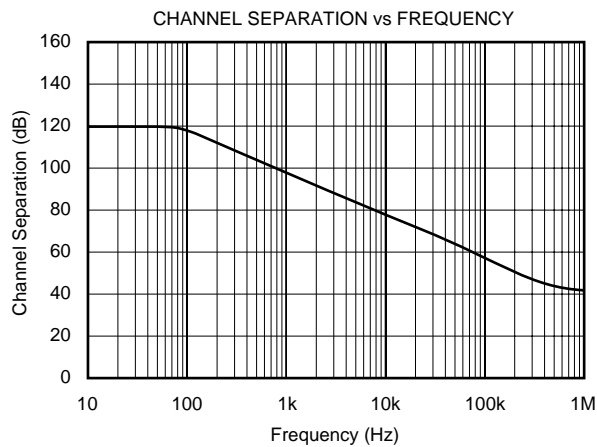
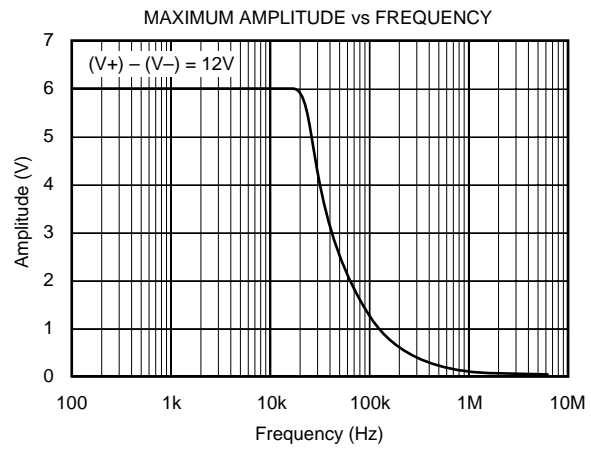
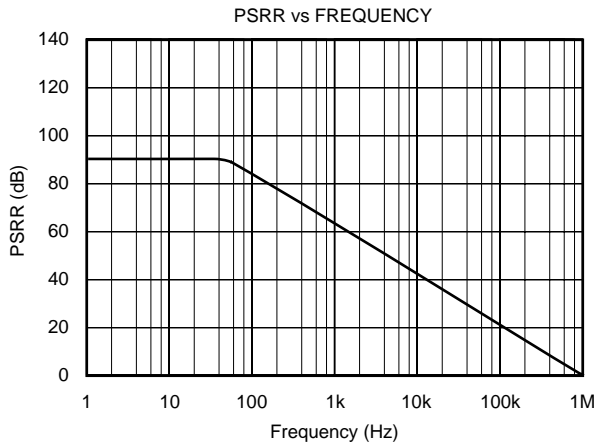
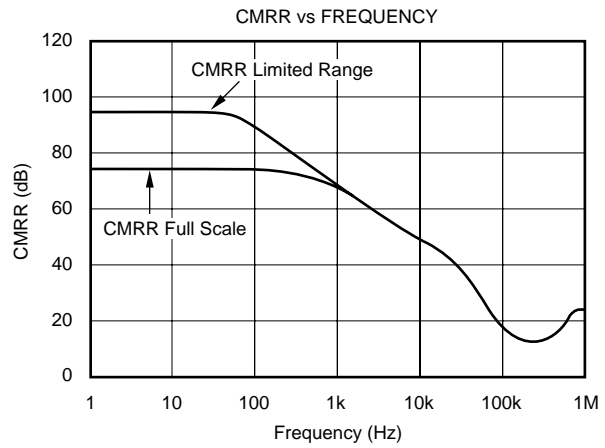
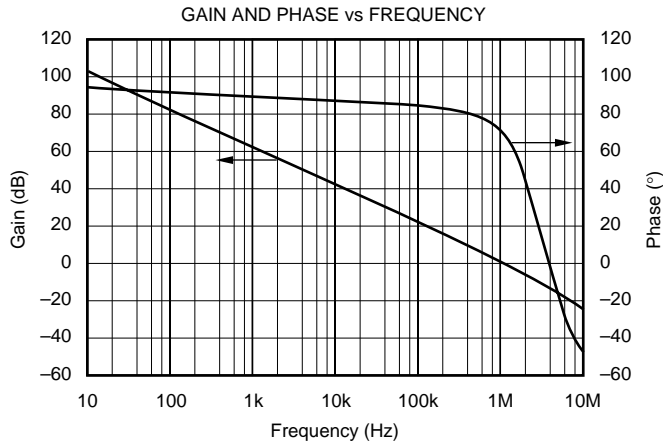
**Boldface** limits apply over the specified temperature range,  $T_A = -40^{\circ}C$  to  $+85^{\circ}C$

At  $T_A = +25^{\circ}C$ ,  $R_L = 20k\Omega$  connected to  $V_S/2$  and  $V_{OUT} = V_S/2$ , unless otherwise noted.

PARAMETER	CONDITION	OPA705NA, UA, PA OPA2705EA, UA, PA OPA4705EA, UA			UNITS
		MIN	TYP	MAX	
<b>OFFSET VOLTAGE</b> Input Offset Voltage <b>Drift</b> vs Power Supply <b>Over Temperature</b> Channel Separation, dc $f = 1kHz$	$V_{OS}$ $dV_{OS}/dT$ PSRR $V_S = \pm 5V, V_{CM} = 0V$ $T_A = -40^{\circ}C$ to $+85^{\circ}C$ $V_S = \pm 2V$ to $\pm 6V, V_{CM} = 0V$ $V_S = \pm 2V$ to $\pm 6V, V_{CM} = 0V$ $R_L = 20k\Omega$		$\pm 0.5$ $\pm 4$ 20 <b>100</b> 1 98	$\pm 5$  100	mV $\mu V/^{\circ}C$ $\mu V/V$ $\mu V/V$ $\mu V/V$ dB
<b>INPUT VOLTAGE RANGE</b> Common-Mode Voltage Range Common-Mode Rejection Ratio <b>over Temperature</b>	$V_{CM}$ CMRR $V_S = \pm 5V, (V-) - 0.3V < V_{CM} < (V+) + 0.3V$ $V_S = \pm 5V, (V-) < V_{CM} < (V+)$ $V_S = \pm 5V, (V-) - 0.3V < V_{CM} < (V+) - 2V$ $V_S = \pm 5V, (V-) < V_{CM} < (V+) - 2V$	$(V-) - 0.3$ 66 66	77 <b>74</b> 96 <b>93</b>	$(V+) + 0.3$	V dB dB dB
<b>INPUT BIAS CURRENT</b> Input Bias Current Input Offset Current	$I_B$ $I_{OS}$ $V_S = \pm 5V, V_{CM} = 0V$ $V_S = \pm 5V, V_{CM} = 0V$		$\pm 1$ $\pm 0.5$	$\pm 10$ $\pm 10$	pA pA
<b>INPUT IMPEDANCE</b> Differential Common-Mode			$4 \cdot 10^9 \parallel 4$ $5 \cdot 10^{12} \parallel 4$		$\Omega \parallel pF$ $\Omega \parallel pF$
<b>NOISE</b> Input Voltage Noise, $f = 0.1Hz$ to $10Hz$ Input Voltage Noise Density, $f = 1kHz$ Current Noise Density, $f = 1kHz$	$e_n$ $i_n$ $V_S = \pm 5V, V_{CM} = 0V$ $V_S = \pm 5V, V_{CM} = 0V$ $V_S = \pm 5V, V_{CM} = 0V$		6 45 2.5		$\mu Vp-p$ $nV/\sqrt{Hz}$ $fA/\sqrt{Hz}$
<b>OPEN-LOOP GAIN</b> Open-Loop Voltage Gain <b>over Temperature</b> <b>over Temperature</b>	$A_{OL}$ $R_L = 100k\Omega, (V-)+0.1V < V_O < (V+)-0.1V$ $R_L = 20k\Omega, (V-)+0.075V < V_O < (V+)-0.075V$ <b><math>R_L = 20k\Omega, (V-)+0.075V &lt; V_O &lt; (V+)-0.075V</math></b> $R_L = 5k\Omega, (V-)+0.15V < V_O < (V+)-0.15V$ <b><math>R_L = 5k\Omega, (V-)+0.15V &lt; V_O &lt; (V+)-0.15V</math></b>	100 100	120 110 <b>106</b> 110 <b>106</b>		dB dB dB dB dB
<b>OUTPUT</b> Voltage Output Swing from Rail  Output Current Short-Circuit Current Capacitive Load Drive	$I_{OUT}$ $I_{SC}$ $C_{LOAD}$ $R_L = 100k\Omega, A_{OL} > 80dB$ $R_L = 20k\Omega, A_{OL} > 100dB$ $R_L = 5k\Omega, A_{OL} > 100dB$ $ V_S - V_{OUT}  < 1V$		40 $\pm 10$ $\pm 40$	75 150	mV mV mV mA mA
<b>FREQUENCY RESPONSE</b> Gain-Bandwidth Product Slew Rate Settling Time, 0.1% 0.01% Overload Recovery Time Total Harmonic Distortion + Noise	GBW SR $t_s$ $t_s$ THD+N $C_L = 100pF$ $G = +1$ $V_S = \pm 5V, G = +1$ $V_S = \pm 5V, 5V$ Step, $G = +1$ $V_S = \pm 5V, 5V$ Step, $G = +1$ $V_{IN} \cdot Gain = V_S$ $V_S = \pm 5V, V_O = 3Vp-p, G = +1, f = 1kHz$		1 0.6 15 20 3 0.02		MHz $V/\mu s$ $\mu s$ $\mu s$ $\mu s$ %
<b>POWER SUPPLY</b> Specified Voltage Range, Single Supply Specified Voltage Range, Dual Supplies Operating Voltage Range Quiescent Current (per amplifier) <b>over Temperature</b>	$V_S$ $V_S$ $I_Q$ $I_Q = 0$	4 $\pm 2$	3.6 to 12 160 <b>200</b>	12 $\pm 6$ 250	V V V $\mu A$ $\mu A$
<b>TEMPERATURE RANGE</b> Specified Range Operating Range Storage Range Thermal Resistance SOT23-5 Surface-Mount MSOP-8 Surface-Mount TSSOP-14 Surface-Mount SO-8 Surface Mount SO-14 Surface Mount DIP-8	$\theta_{JA}$	-40 -55 -65		85 125 150	$^{\circ}C$ $^{\circ}C$ $^{\circ}C$ $^{\circ}C/W$ $^{\circ}C/W$ $^{\circ}C/W$ $^{\circ}C/W$ $^{\circ}C/W$ $^{\circ}C/W$

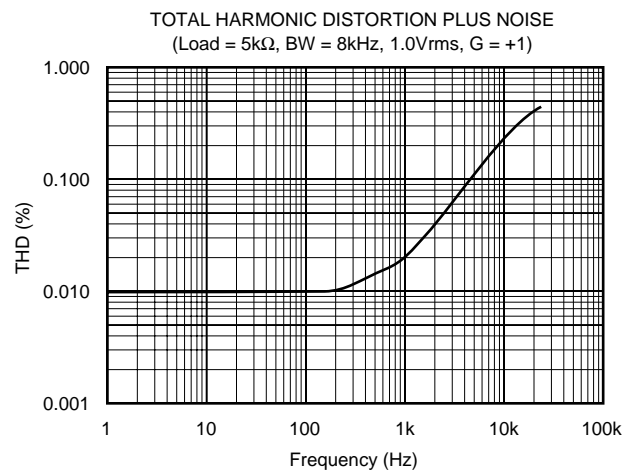
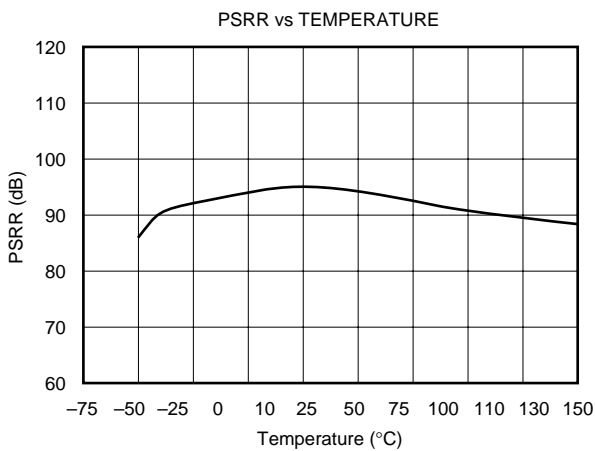
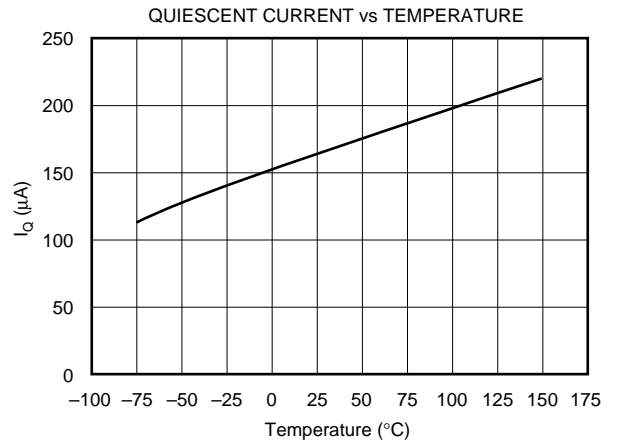
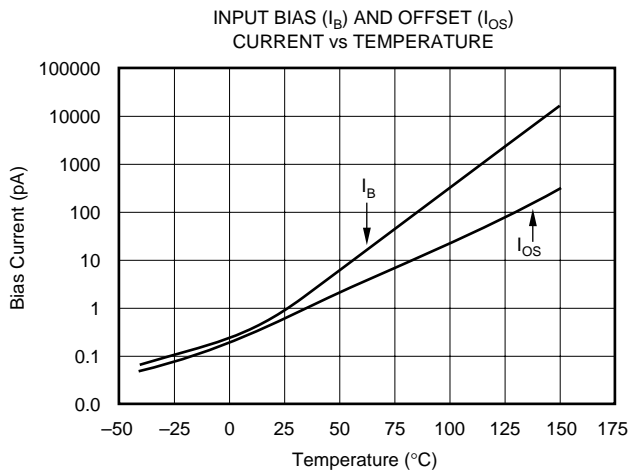
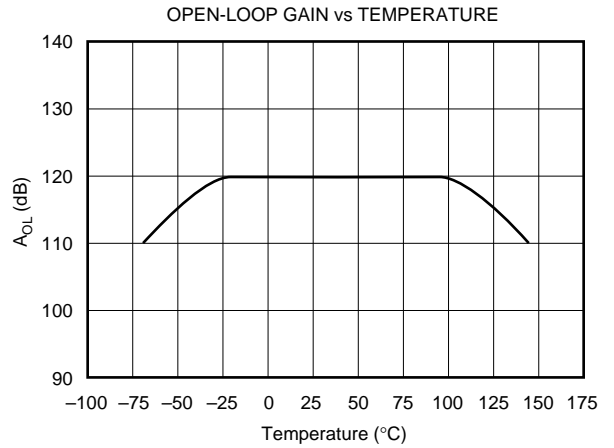
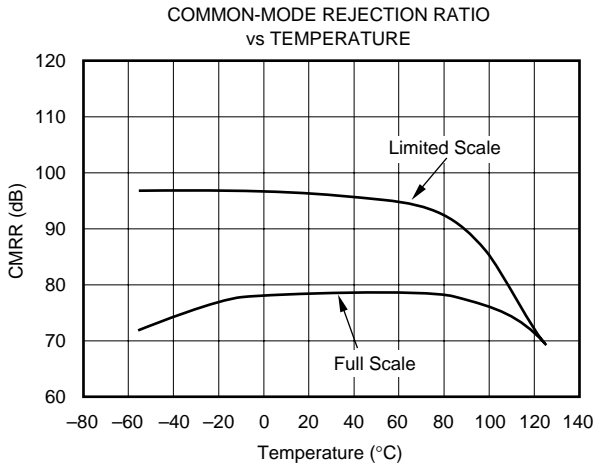
# TYPICAL CHARACTERISTICS

At  $T_A = +25^\circ\text{C}$ ,  $V_S = \pm 5\text{V}$ , and  $R_L = 20\text{k}\Omega$ , unless otherwise noted.



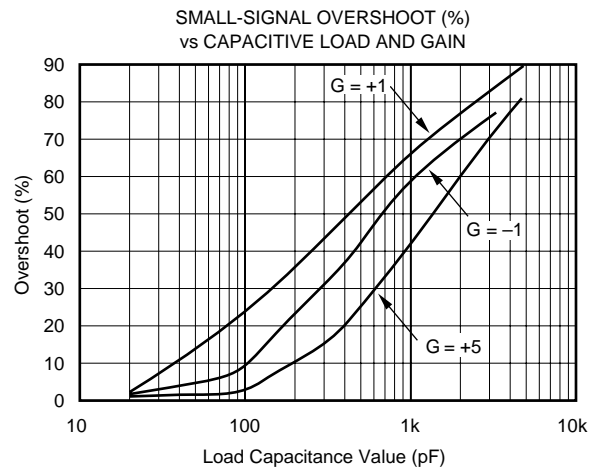
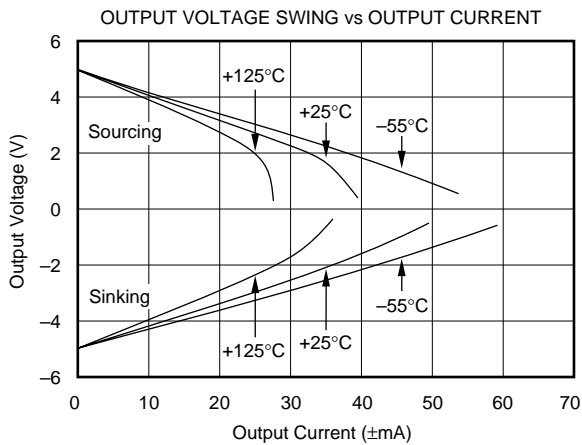
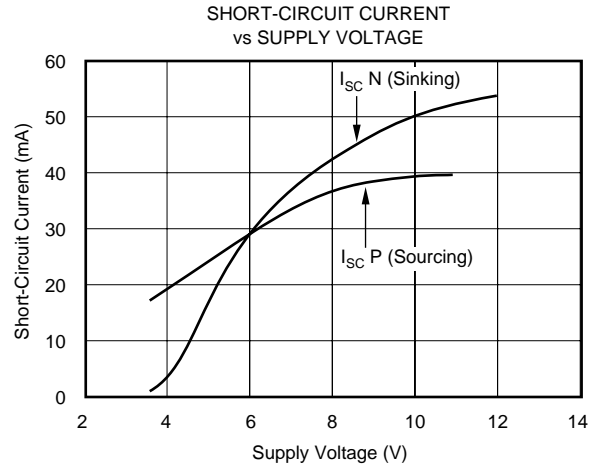
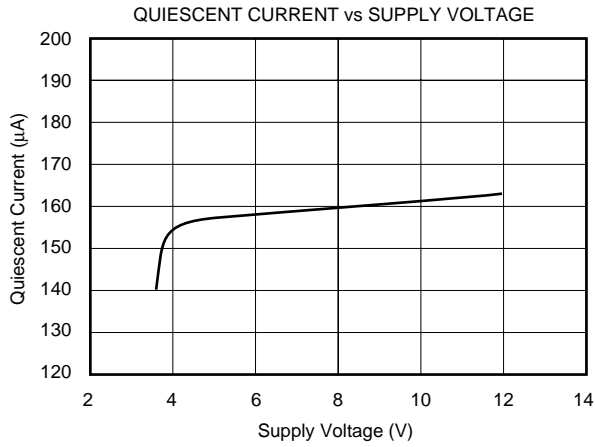
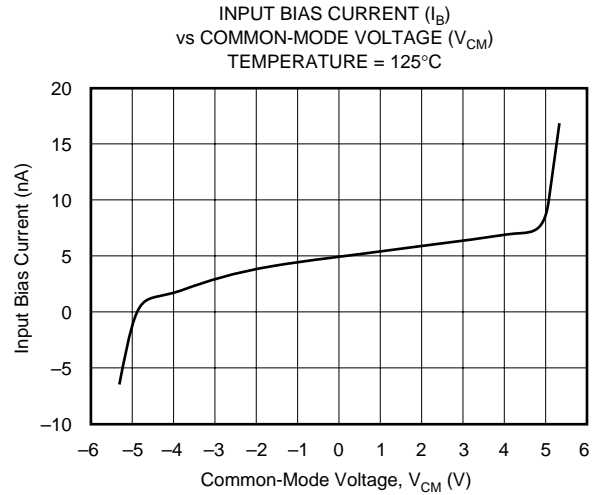
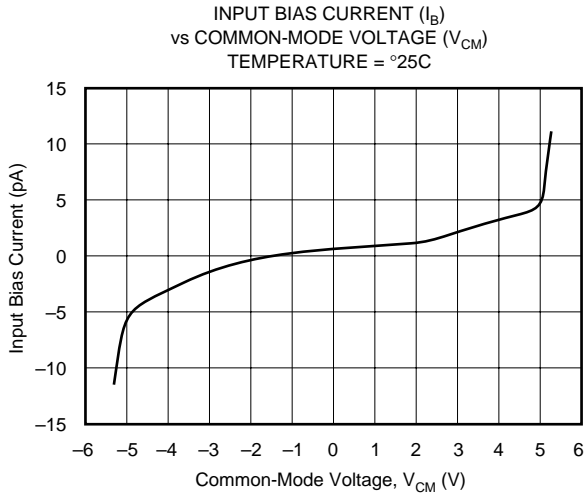
# TYPICAL CHARACTERISTICS (Cont.)

At  $T_A = +25^\circ\text{C}$ ,  $V_S = \pm 5\text{V}$ , and  $R_L = 20\text{k}\Omega$ , unless otherwise noted.



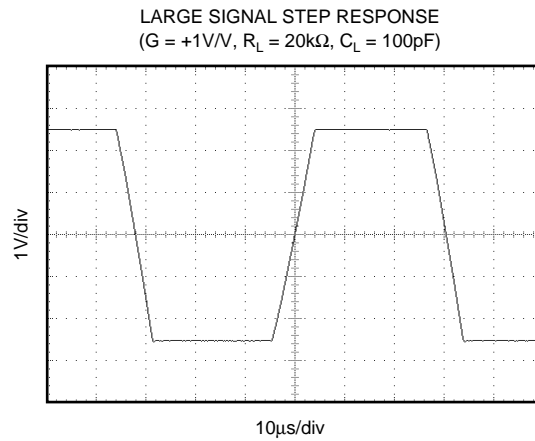
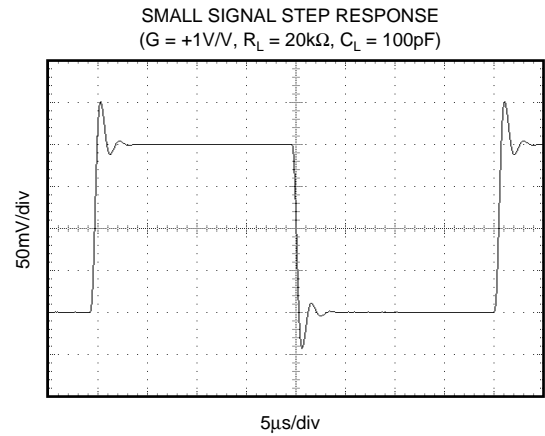
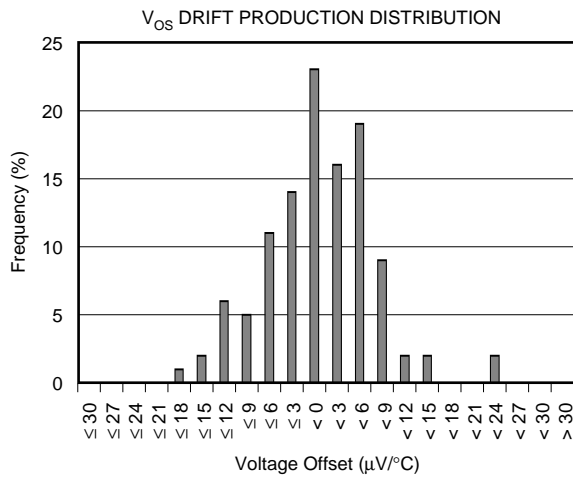
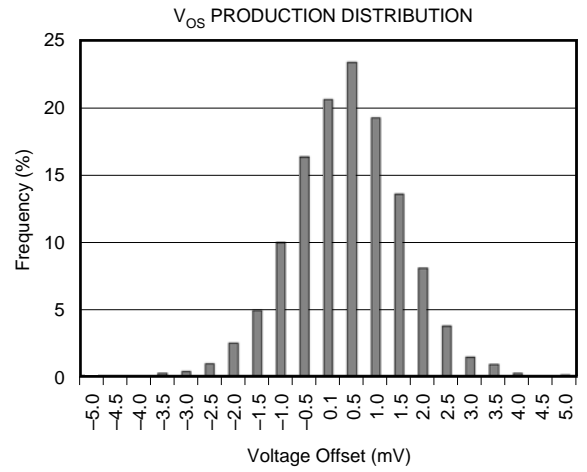
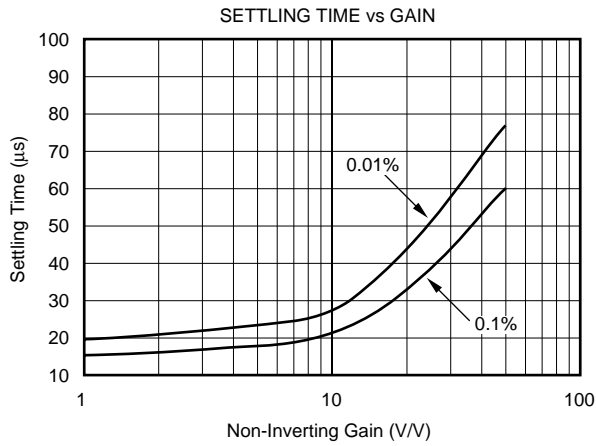
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At  $T_A = +25^\circ\text{C}$ ,  $V_S = \pm 5\text{V}$ , and  $R_L = 20\text{k}\Omega$ , unless otherwise noted.



# TYPICAL CHARACTERISTICS (Cont.)

At  $T_A = +25^\circ\text{C}$ ,  $V_S = \pm 5\text{V}$ , and  $R_L = 20\text{k}\Omega$ , unless otherwise noted.



# APPLICATIONS INFORMATION

OPA705 series op amps can operate on 160 $\mu$ A quiescent current from a single (or split) supply in the range of 4V to 12V ( $\pm 2$ V to  $\pm 6$ V), making them highly versatile and easy to use. The OPA705 is unity-gain stable and offers 1MHz bandwidth and 0.6V/ $\mu$ s slew rate.

Rail-to-rail input and output swing helps maintain dynamic range, especially in low supply applications. Figure 1 shows the input and output waveforms for the OPA705 in unity-gain configuration. Operation is from a  $\pm 5$ V supply with a 100k $\Omega$  load connected to  $V_S/2$ . The input is a 10Vp-p sinusoid. Output voltage is approximately 10Vp-p.

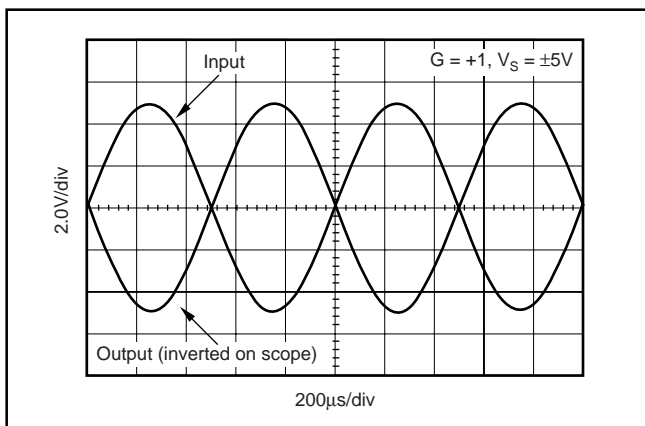


FIGURE 1. Rail-to-Rail Input and Output.

Power-supply pins should be bypassed with 1000pF ceramic capacitors in parallel with 1 $\mu$ F tantalum capacitors.

## OPERATING VOLTAGE

OPA705 series op amps are fully specified and guaranteed from +4V to +12V over a temperature range of  $-40^{\circ}$ C to  $+85^{\circ}$ C. Parameters that vary significantly with operating voltages or temperature are shown in the Typical Characteristics.

## RAIL-TO-RAIL INPUT

The input common-mode voltage range of the OPA705 series extends 300mV beyond the supply rails at room temperature. This is achieved with a complementary input stage—an N-channel input differential pair in parallel with a P-channel differential pair, as shown in Figure 2. The N-channel pair is active for input voltages close to the positive rail, typically  $(V_+) - 2.0$ V to 300mV above the positive supply, while the P-channel pair is on for inputs from 300mV below the negative supply to approximately  $(V_+) - 1.5$ V. There is a small transition region, typically  $(V_+) - 2.0$ V to  $(V_+) - 1.5$ V, in which both pairs are on. This 500mV transition region can vary  $\pm 100$ mV with process variation. Thus, the transition region (both stages on) can range from  $(V_+) - 2.1$ V to  $(V_+) - 1.4$ V on the low end, up to  $(V_+) - 1.9$ V to  $(V_+) - 1.6$ V on the high end. Within the 500mV transition region PSRR, CMRR, offset voltage, and offset drift, and THD may vary compared to operation outside this region.

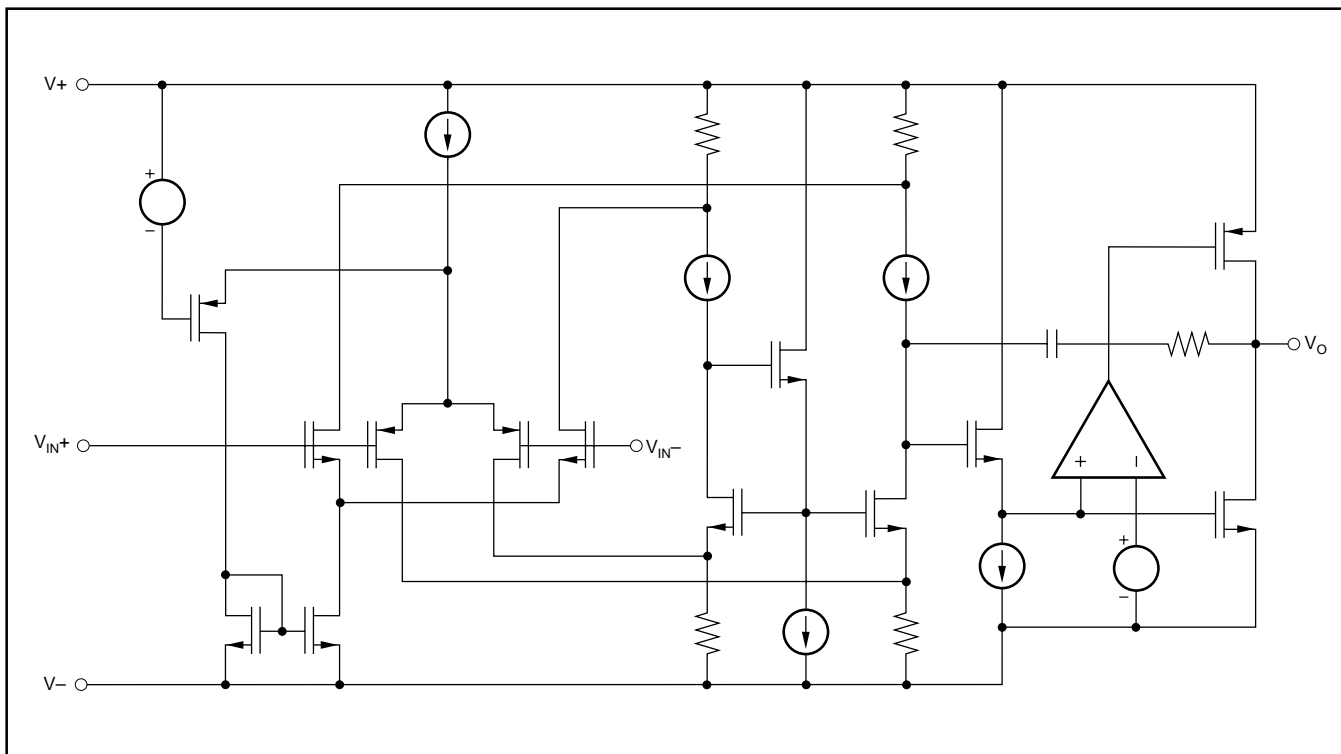


FIGURE 2. Simplified Schematic.



## INPUT VOLTAGE

Device inputs are protected by ESD diodes that will conduct if the input voltages exceed the power supplies by more than approximately 300mV. Momentary voltages greater than 300mV beyond the power supply can be tolerated if the current is limited to 10mA. This is easily accomplished with an input resistor, as shown in Figure 3. Many input signals are inherently current-limited to less than 10mA; therefore, a limiting resistor is not always required. The OPA705 features no phase inversion when the inputs extend beyond supplies if the input current is limited, as seen in Figure 4.

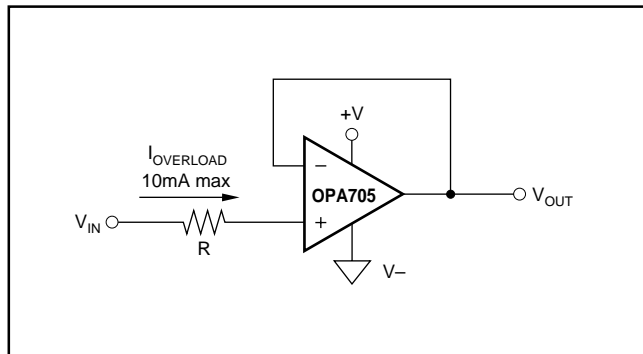


FIGURE 3. Input Current Protection for Voltages Exceeding the Supply Voltage.

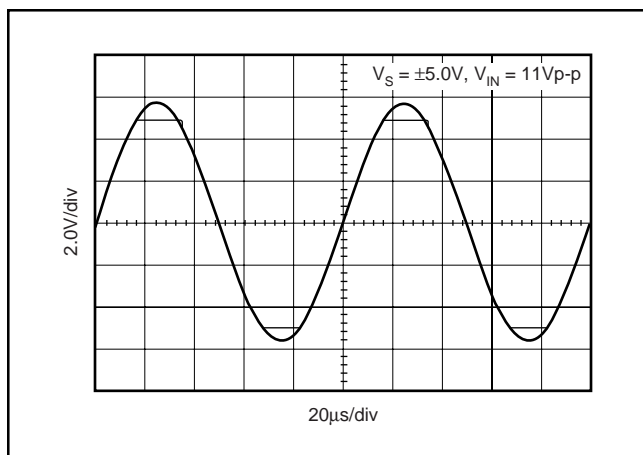


FIGURE 4. OPA705—No Phase Inversion with Inputs Greater than the Power-Supply Voltage.

## RAIL-TO-RAIL OUTPUT

A class AB output stage with common-source transistors is used to achieve rail-to-rail output. This output stage is capable of driving 1kΩ loads connected to any point between V+ and ground. For light resistive loads (> 100kΩ), the output voltage can swing to 40mV from the supply rail. With moderate resistive loads (20kΩ), the output can swing to within 75mV from the supply rails while maintaining high open-loop gain (see the typical performance curve “Output Voltage Swing vs Output Current”).

## CAPACITIVE LOAD AND STABILITY

The OPA705 series op amps can drive up to 1000pF pure capacitive load. Increasing the gain enhances the amplifier’s ability to drive greater capacitive loads (see the typical performance curve “Small Signal Overshoot vs Capacitive Load”).

One method of improving capacitive load drive in the unity-gain configuration is to insert a 10Ω to 20Ω resistor inside the feedback loop, as shown in Figure 5. This reduces ringing with large capacitive loads while maintaining DC accuracy.

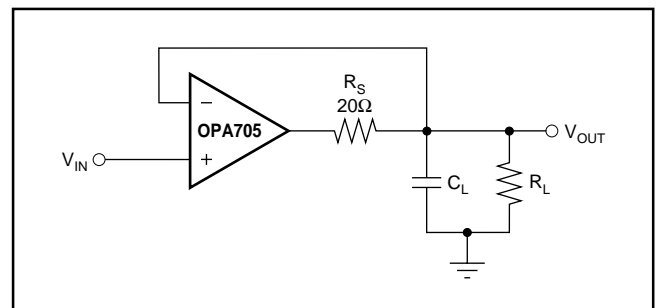


FIGURE 5. Series Resistor in Unity-Gain Buffer Configuration Improves Capacitive Load Drive.

## APPLICATION CIRCUITS

The OPA705 series op amps are optimized for driving medium-speed sampling data converters. Figure 6 shows the OPA2705 in a dual-supply buffered reference configuration for the DAC7644. The DAC7644 is a 16-bit, low-power, quad-voltage output converter. Small size makes the combination ideal for automatic test equipment, data acquisition systems, and other low-power space-limited applications.

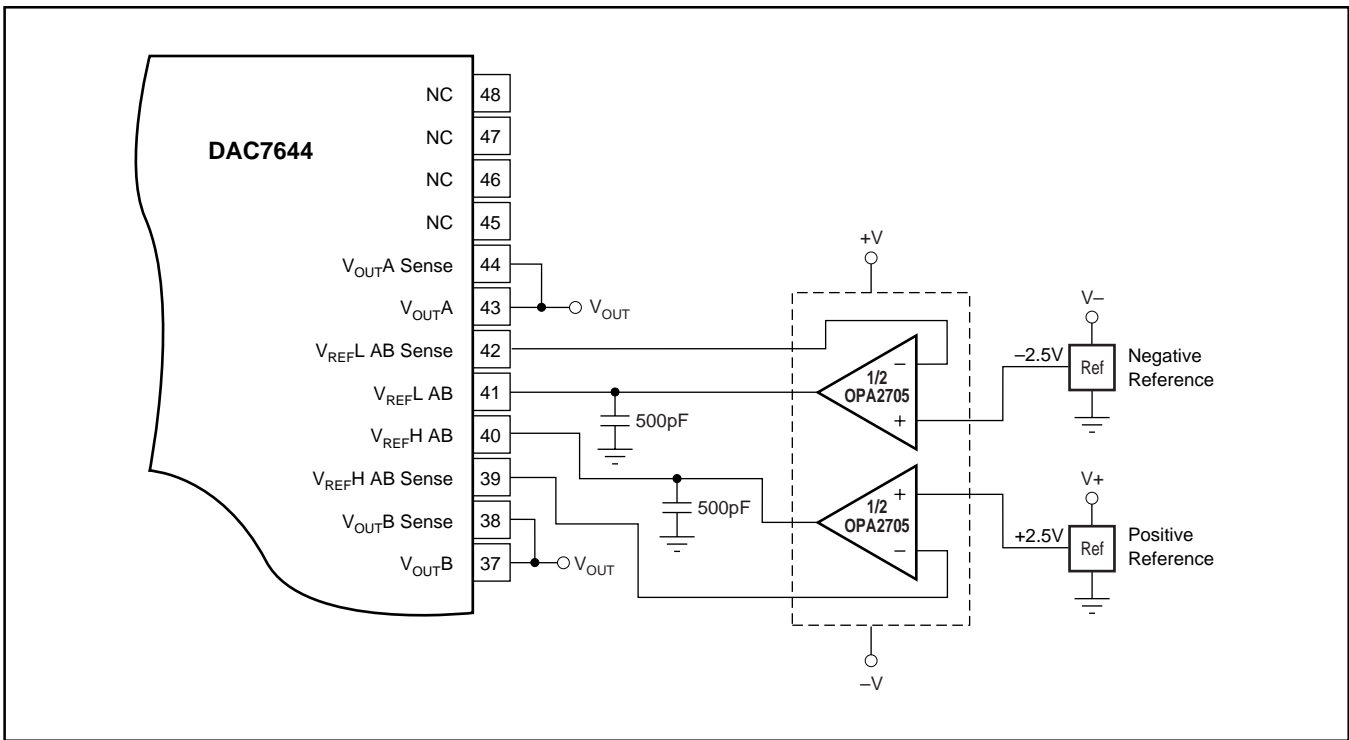


FIGURE 6. OPA705 as Dual Supply Configuration-Buffered References for the DAC7644.

**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
OPA2705EA/250	ACTIVE	VSSOP	DGK	8	250	Green (RoHS & no Sb/Br)	CU NIPDAUAG	Level-2-260C-1 YEAR	-40 to 85	B05	<a href="#">Samples</a>
OPA2705EA/250G4	ACTIVE	VSSOP	DGK	8	250	Green (RoHS & no Sb/Br)	CU NIPDAUAG	Level-2-260C-1 YEAR	-40 to 85	B05	<a href="#">Samples</a>
OPA2705PA	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	-40 to 85	OPA2705PA	<a href="#">Samples</a>
OPA2705PAG4	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	-40 to 85	OPA2705PA	<a href="#">Samples</a>
OPA2705UA	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 2705UA	<a href="#">Samples</a>
OPA2705UAG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 2705UA	<a href="#">Samples</a>
OPA4705EA/250	ACTIVE	TSSOP	PW	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 4705EA	<a href="#">Samples</a>
OPA4705EA/250G4	ACTIVE	TSSOP	PW	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 4705EA	<a href="#">Samples</a>
OPA4705EA/2K5	ACTIVE	TSSOP	PW	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 4705EA	<a href="#">Samples</a>
OPA4705EA/2K5G4	ACTIVE	TSSOP	PW	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 4705EA	<a href="#">Samples</a>
OPA705NA/250	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	-40 to 85	A05	<a href="#">Samples</a>
OPA705NA/250G4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	-40 to 85	A05	<a href="#">Samples</a>
OPA705NA/3K	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	-40 to 85	A05	<a href="#">Samples</a>
OPA705PA	ACTIVE	PDIP	P	8	50	Green (RoHS & no Sb/Br)	CU NIPDAU	N / A for Pkg Type	-40 to 85	OPA705PA	<a href="#">Samples</a>
OPA705UA	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 705UA	<a href="#">Samples</a>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

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**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

<sup>(2)</sup> **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of  $\leq 1000$ ppm threshold. Antimony trioxide based flame retardants must also meet the  $\leq 1000$ ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

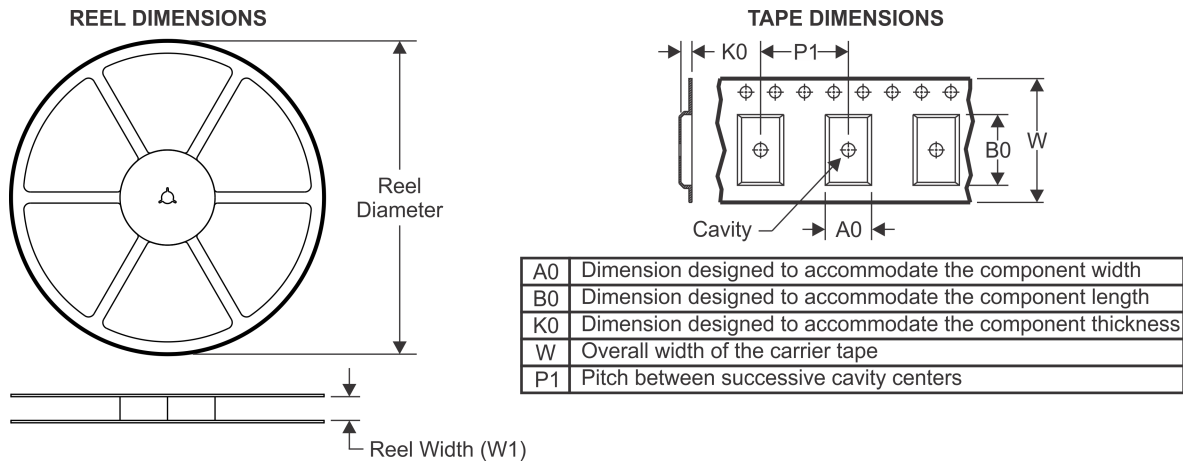
<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
OPA2705EA/250	VSSOP	DGK	8	250	180.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
OPA4705EA/250	TSSOP	PW	14	250	180.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
OPA4705EA/2K5	TSSOP	PW	14	2500	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
OPA705NA/250	SOT-23	DBV	5	250	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
OPA705NA/3K	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
OPA2705EA/250	VSSOP	DGK	8	250	210.0	185.0	35.0
OPA4705EA/250	TSSOP	PW	14	250	210.0	185.0	35.0
OPA4705EA/2K5	TSSOP	PW	14	2500	367.0	367.0	35.0
OPA705NA/250	SOT-23	DBV	5	250	180.0	180.0	18.0
OPA705NA/3K	SOT-23	DBV	5	3000	180.0	180.0	18.0

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